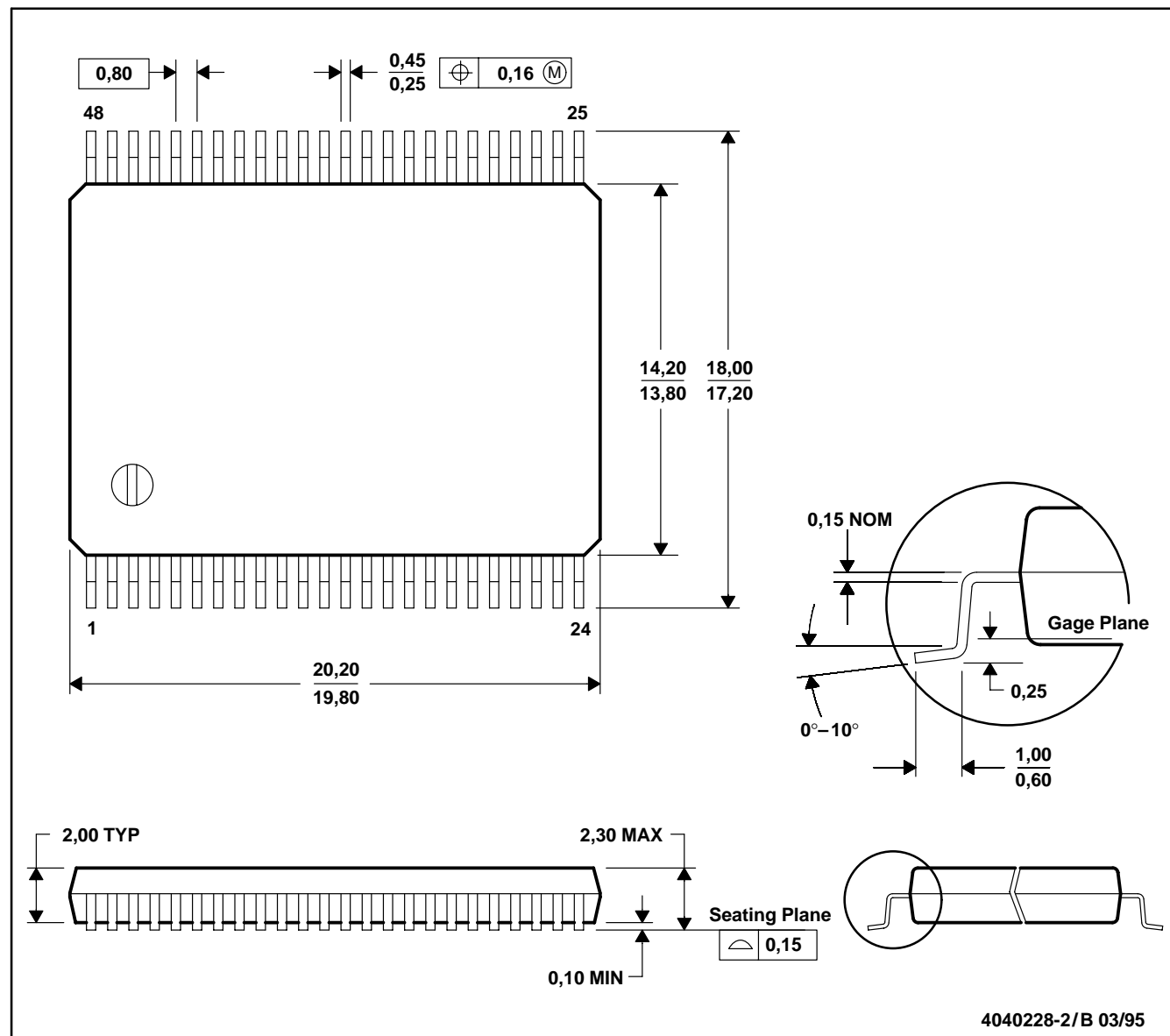


FT (R-PDFP-G48)

PLASTIC DUAL FLATPACK



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Contact field sales office to determine if a tighter coplanarity requirement is available for this package.

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